

## Wiring, Printed - Component

**COMPANY**

**PRINTED CIRCUITS L L C**  
 1200 W 96TH ST  
 MINNEAPOLIS, MN 55431-2606 United States

E67398

Type	Cond Width		Cond Thk	SS/DSO	Max Area Diam	Report Date After	Surface Mount Technology	Assembly Solder		Solder Limits		Max Oper Temp		Meets UL796	C T
	Min	Edge						Process	Process	°C	sec	°C	Class		
	mm	mm						Temp °C	Cycles	°C	sec	°C	Class		
<b>Flexible printed wiring boards</b>															
-F	0.13	0.51	17.8	DS	25.4	No	-	-	-	288	10	105	-	-	-
-F-0	0.13	0.51	17.8	DS	25.4	No	-	-	-	288	10	105	V-0	-	-
<b>Multilayer printed wiring boards</b>															
2	0.15	0.46	34.3	DS	254	No	-	-	-	260	20	105	-	-	-
2-0	0.15	0.46	34.3	DS	254	No	-	-	-	260	20	105	V-0	-	-
3-0	0.05	0.13	17.8	DS	101.6	No	-	-	-	288	10	120	V-0	-	-
4	0.05	0.13	17.8	DS	101.6	No	-	-	-	288	10	120	-	-	-
<b>Multilayer rigid flex composite FMIC</b>															
1	0.25	0.76	17.8	DS	304.8	No	-	-	-	260	20	105	-	-	-
FF-0	0.075	0.075	17 Int:68	DS	101.6	No	-	-	-	288	10	105	V-0	-	-
FP-0	0.10	0.10	17 Int:34	DS	101.6	No	-	-	-	288	10	130	V-0	-	-
GF-0	0.075	0.075	17 Int:68	DS	101.6	No	-	-	-	288	10	105	V-0	-	-
GP-0	0.10	0.10	18 Int:34	DS	101.6	No	-	-	-	288	10	130	V-0	-	-
<b>Single layer printed wiring boards</b>															
1-0	0.25	0.76	17.8	DS	304.8	No	-	-	-	260	20	105	V-0	-	-

Marking: Company name or tradename "2P533", "FSCM 65114", "MFR65114", "PCI" or file number and type designation. May be followed by a suffix to denote factory identification or flammability classification.

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